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Date Mailed: February 22, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yi-Shung CHAUG, *et al.*

Appl. No. 10/665,992

Filed: September 19, 2003

For: PROCESS FOR FORMING A  
PATTERNED THIN FILM  
STRUCTURE FOR IN-MOLD  
DECORATION

Art Unit: 1734

Confirmation No.: 5386

Examiner: Chan, Sing P

Attorney Docket: 07783.0101.CPUS01

**RESPONSE TO OFFICE ACTION**

**MAIL STOP: AMENDMENT**

Commissions for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Office Action dated August 23, 2005, and is submitted on or before the extended due date of **February 23, 2006**. A constructive Petition under 1.136(a)(3) for a three-month extension of time and the requisite fee of \$510.00 under 1.17(a)(3) are enclosed herewith. The Examiner is requested to enter the amendments and reconsider the application.

The U.S. Patent and Trademark Office is hereby authorized to charge any fee deficiency, including fees under §1.17; or credit any overpayment, to our Deposit Account No. 08-3038 referencing Atty. Dkt. No. 07783.0101.CPUS01.

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